Application Data Sheet

Application Information

Application number::

Filing Date::

Application Type::

Subject Matter::

Title ::

Attorney Docket Number::

Total Drawing Sheets::

Small Entity?::

Regular

Utility

SEMICONDUCTOR DEVICE

AND FABRICATING **METHOD THEREOF**

0756-7217

10

No

Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan Akira

Given Name:: Middle Name::

Family Name::

ISHIKAWA

Name Suffix::

City of Residence::

State or Province of Residence::

Kanagawa

Country of Residence::

Japan

Atsugi

Street of mailing address::

c/o Semiconductor Energy

Laboratory Co., Ltd.

398, Hase

City of mailing address:: Atsugi-shi State or Province of mailing address:: Kanagawa-ken Country of mailing address:: Japan Postal or Zip Code of mailing address:: 243-0036 Applicant Authority Type:: Inventor Primary Citizenship Country:: Japan Given Name:: Shingo Middle Name:: Family Name:: **EGUCHI** Name Suffix:: City of Residence:: Tochigi State or Province of Residence:: Tochigi Country of Residence:: Japan Street of mailing address:: c/o Semiconductor Energy Laboratory Co., Ltd. 398, Hase City of mailing address:: Atsugi-shi State or Province of mailing address:: Kanagawa-ken Country of mailing address:: Japan Postal or Zip Code of mailing address:: 243-0036 Applicant Authority Type:: Inventor Primary Citizenship Country:: Japan Given Name:: Seiji Middle Name:: Family Name:: ODA - -

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Kurashiki

Name Suffix::

City of Residence::

Initial 10/31/03

State or Province of Residence:: Okayama

Country of Residence:: Japan

Street of mailing address:: c/o Sharp Kabushiki Kaisha

22-22, Nagaike-cho, Abeno-ku

City of mailing address:: Osaki-shi

State or Province of mailing address:: Osaki

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 545-0013

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Given Name:: Yoshinori

Middle Name::

Family Name:: HIGAMI

Name Suffix::

City of Residence:: Fukuyama

State or Province of Residence:: Hiroshima

Country of Residence:: Japan

Street of mailing address:: c/o Sharp Kabushiki Kaisha

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State or Province of mailing address:: Osaki

Country of mailing address:: Japan

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Correspondence Information

Correspondence Customer Number ::

31780

E-Mail address::

erobinson@riplo.com

Representative Information

Representative Customer Number::

31780

Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-320785	11/05/2002	Yes

Assignee Information

Assignee name::

Semiconductor Energy

Laboratory Co., Ltd.

Street of mailing address::

398 Hase

City of mailing address::

Atsugi-shi

State or Province of mailing address::

Kangawa-ken

Page #4

Initial 10/31/03

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 243-0036

Assignee name:: Sharp Kabushiki Kaisha

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State or Province of mailing address:: Osaka

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 545-0013